

### General Description

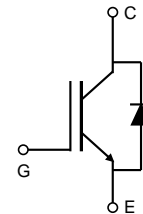
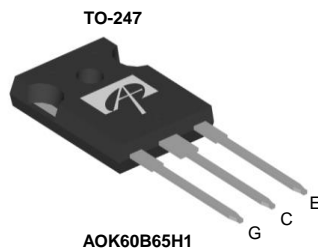
- Latest Alpha IGBT ( $\alpha$  IGBT) technology
- 650V breakdown voltage
- Very fast and soft recovery freewheeling diode
- High efficient turn-on di/dt controllability
- Very high switching speed
- Low turn-off switching loss and softness
- Very good EMI behavior
- Short-circuit ruggedness

### Applications

- Welding Machines
- Motor Drives
- UPS & Solar Inverters
- Very High Switching Frequency Applications

### Product Summary

$V_{CE}$	650V
$I_C$ ( $T_C=100^\circ\text{C}$ )	60A
$V_{CE(sat)}$ ( $T_J=25^\circ\text{C}$ )	1.88V



Orderable Part Number	Package Type	Form	Minimum Order Quantity
AOK60B65H1	TO247	Tube	240

### Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	AOK60B65H1	Units
Collector-Emitter Voltage	$V_{CE}$	650	V
Gate-Emitter Voltage	$V_{GE}$	$\pm 30$	V
Continuous Collector Current	$I_C$	$T_C=25^\circ\text{C}$	120
		$T_C=100^\circ\text{C}$	60
Pulsed Collector Current, Limited by $T_{Jmax}$	$I_{CM}$	180	A
Turn off SOA, $V_{CE} \leq 650\text{V}$ , Limited by $T_{Jmax}$	$I_{LM}$	180	A
Continuous Diode Forward Current	$I_F$	$T_C=25^\circ\text{C}$	54
		$T_C=100^\circ\text{C}$	27
Diode Pulsed Current, Limited by $T_{Jmax}$	$I_{FM}$	180	A
Short circuit withstanding time <sup>1)</sup> $V_{GE}=15\text{V}$ , $V_{CC} \leq 300\text{V}$ , $T_J \leq 175^\circ\text{C}$	$t_{SC}$	5	$\mu\text{s}$
Power Dissipation	$P_D$	$T_C=25^\circ\text{C}$	500
		$T_C=100^\circ\text{C}$	250
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to 175	$^\circ\text{C}$
Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds	$T_L$	300	$^\circ\text{C}$

### Thermal Characteristics

Parameter	Symbol	AOK60B65H1	Units
Maximum Junction-to-Ambient	$R_{\theta JA}$	40	$^\circ\text{C/W}$
Maximum IGBT Junction-to-Case	$R_{\theta JC}$	0.3	$^\circ\text{C/W}$
Maximum Diode Junction-to-Case	$R_{\theta JC}$	1	$^\circ\text{C/W}$

1) Allowed number of short circuits: <1000; time between short circuits: >1s.

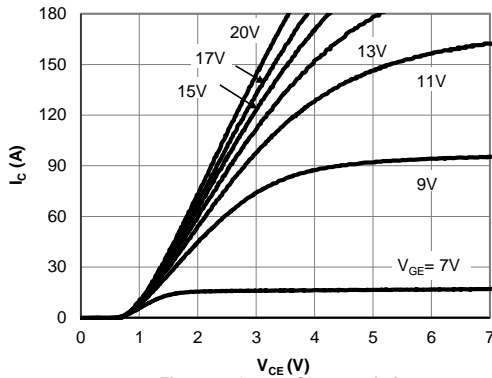
**Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Units	
<b>STATIC PARAMETERS</b>							
$BV_{CES}$	Collector-Emitter Breakdown Voltage	$I_C=1\text{mA}, V_{GE}=0\text{V}, T_J=25^\circ\text{C}$	650	-	-	V	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$V_{GE}=15\text{V}, I_C=60\text{A}$	$T_J=25^\circ\text{C}$	-	1.88	2.35	V
			$T_J=125^\circ\text{C}$	-	2.34	-	
			$T_J=175^\circ\text{C}$	-	2.6	-	
$V_F$	Diode Forward Voltage	$V_{GE}=0\text{V}, I_C=60\text{A}$	$T_J=25^\circ\text{C}$	-	2.08	2.6	V
			$T_J=125^\circ\text{C}$	-	2.25	-	
			$T_J=175^\circ\text{C}$	-	2.2	-	
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$V_{CE}=5\text{V}, I_C=1\text{mA}$	-	4.8	-	V	
$I_{CES}$	Zero Gate Voltage Collector Current	$V_{CE}=650\text{V}, V_{GE}=0\text{V}$	$T_J=25^\circ\text{C}$	-	-	10	$\mu\text{A}$
			$T_J=125^\circ\text{C}$	-	-	1000	
			$T_J=175^\circ\text{C}$	-	-	15000	
$I_{GES}$	Gate-Emitter leakage current	$V_{CE}=0\text{V}, V_{GE}=\pm 30\text{V}$	-	-	$\pm 100$	nA	
$g_{FS}$	Forward Transconductance	$V_{CE}=20\text{V}, I_C=60\text{A}$	-	44	-	S	
<b>DYNAMIC PARAMETERS</b>							
$C_{ies}$	Input Capacitance	$V_{GE}=0\text{V}, V_{CC}=25\text{V}, f=1\text{MHz}$	-	2557	-	pF	
$C_{oes}$	Output Capacitance		-	247	-	pF	
$C_{res}$	Reverse Transfer Capacitance		-	77	-	pF	
$Q_g$	Total Gate Charge	$V_{GE}=15\text{V}, V_{CC}=520\text{V}, I_C=60\text{A}$	-	90	-	nC	
$Q_{ge}$	Gate to Emitter Charge		-	22	-	nC	
$Q_{gc}$	Gate to Collector Charge		-	38	-	nC	
$I_{C(SC)}$	Short circuit collector current	$V_{GE}=15\text{V}, V_{CC}=300\text{V},$ $t_{sc} \leq 5\mu\text{s}, T_J \leq 175^\circ\text{C}$	-	386	-	A	
$R_g$	Gate resistance	$V_{GE}=0\text{V}, V_{CC}=0\text{V}, f=1\text{MHz}$	-	12	-	$\Omega$	
<b>SWITCHING PARAMETERS, (Load Inductive, T<sub>J</sub>=25°C)</b>							
$t_{D(on)}$	Turn-On Delay Time	$T_J=25^\circ\text{C}$ $V_{GE}=15\text{V}, V_{CC}=400\text{V}, I_C=60\text{A},$ $R_G=5\Omega$	-	39	-	ns	
$t_r$	Turn-On Rise Time		-	76	-	ns	
$t_{D(off)}$	Turn-Off Delay Time		-	153	-	ns	
$t_f$	Turn-Off Fall Time		-	78	-	ns	
$E_{on}$	Turn-On Energy		-	2.42	-	mJ	
$E_{off}$	Turn-Off Energy		-	1.17	-	mJ	
$E_{total}$	Total Switching Energy		-	3.59	-	mJ	
$t_{rr}$	Diode Reverse Recovery Time		$T_J=25^\circ\text{C}$	-	288	-	ns
$Q_{rr}$	Diode Reverse Recovery Charge		$I_F=60\text{A}, dl/dt=200\text{A}/\mu\text{s}, V_{CC}=400\text{V}$	-	1.2	-	$\mu\text{C}$
$I_{rm}$	Diode Peak Reverse Recovery Current			-	7.8	-	A
<b>SWITCHING PARAMETERS, (Load Inductive, T<sub>J</sub>=175°C)</b>							
$t_{D(on)}$	Turn-On Delay Time	$T_J=175^\circ\text{C}$ $V_{GE}=15\text{V}, V_{CC}=400\text{V}, I_C=60\text{A},$ $R_G=5\Omega$	-	38	-	ns	
$t_r$	Turn-On Rise Time		-	80	-	ns	
$t_{D(off)}$	Turn-Off Delay Time		-	184	-	ns	
$t_f$	Turn-Off Fall Time		-	84	-	ns	
$E_{on}$	Turn-On Energy		-	2.86	-	mJ	
$E_{off}$	Turn-Off Energy		-	1.77	-	mJ	
$E_{total}$	Total Switching Energy		-	4.63	-	mJ	
$t_{rr}$	Diode Reverse Recovery Time		$T_J=175^\circ\text{C}$	-	465	-	ns
$Q_{rr}$	Diode Reverse Recovery Charge		$I_F=60\text{A}, dl/dt=200\text{A}/\mu\text{s}, V_{CC}=400\text{V}$	-	2.8	-	$\mu\text{C}$
$I_{rm}$	Diode Peak Reverse Recovery Current			-	11	-	A

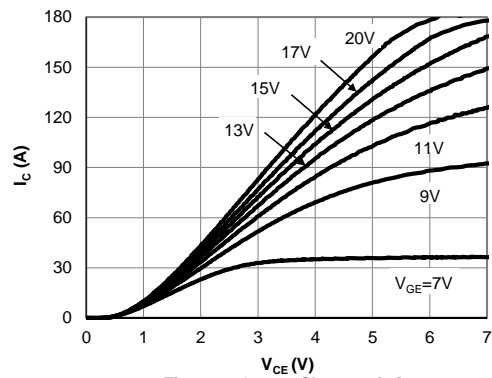
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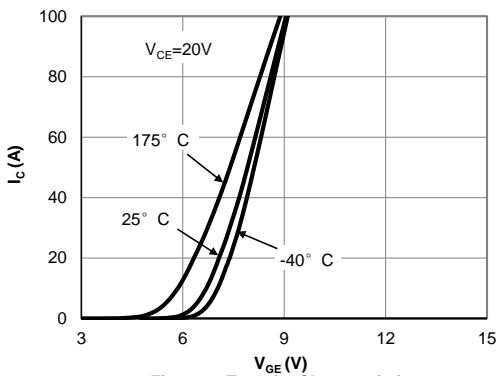
**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**



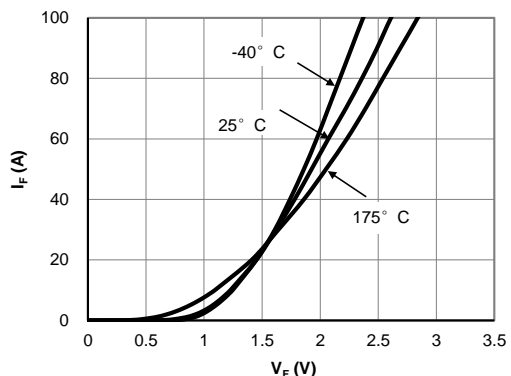
**Figure 1: Output Characteristic**  
( $T_j=25^\circ\text{C}$ )



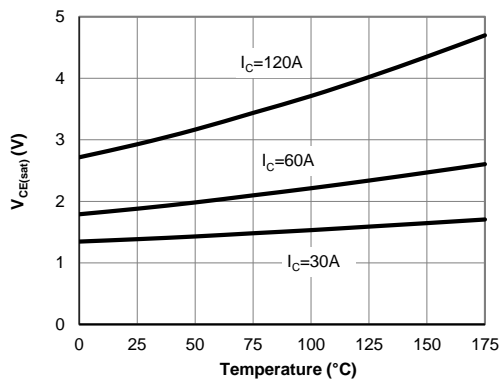
**Figure 2: Output Characteristic**  
( $T_j=175^\circ\text{C}$ )



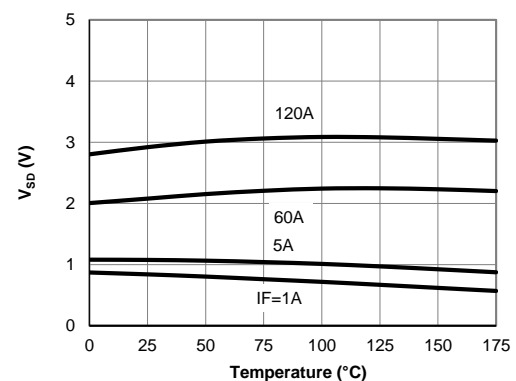
**Figure 3: Transfer Characteristic**



**Figure 4: Diode Characteristic**

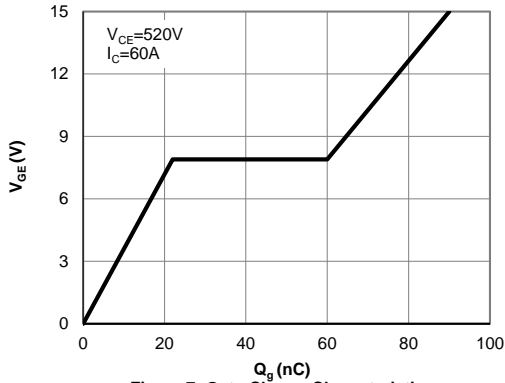


**Figure 5: Collector-Emitter Saturation Voltage vs. Junction Temperature**

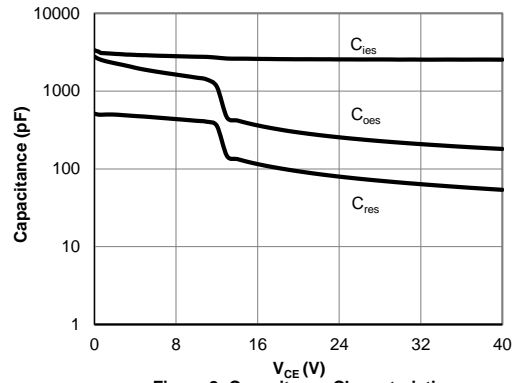


**Figure 6: Diode Forward voltage vs. Junction Temperature**

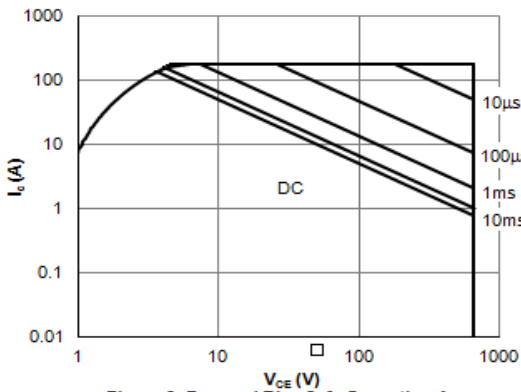
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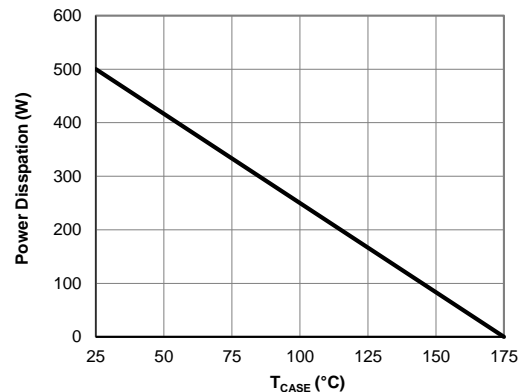
**Figure 7: Gate-Charge Characteristics**



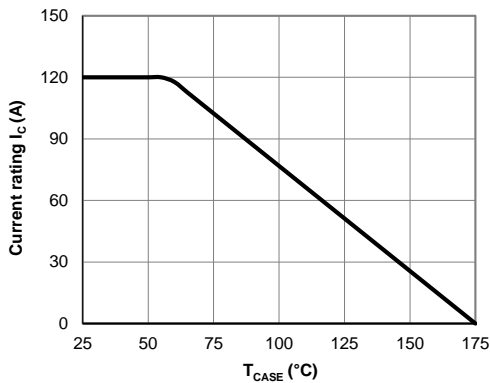
**Figure 8: Capacitance Characteristic**



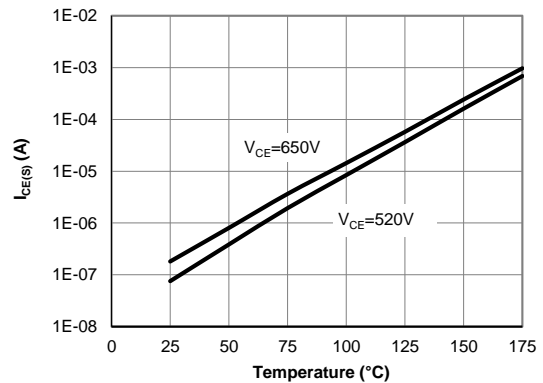
**Figure 9: Forward Bias Safe Operating Area**  
( $T_c=25^\circ\text{C}$ ,  $V_{GE}=15\text{V}$ )



**Figure 10: Power Dissipation as a Function of Case**

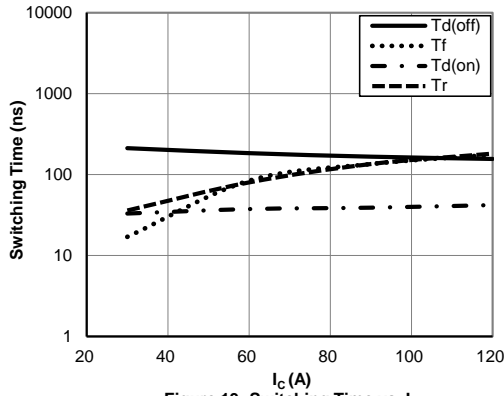


**Figure 11: Current De-rating**

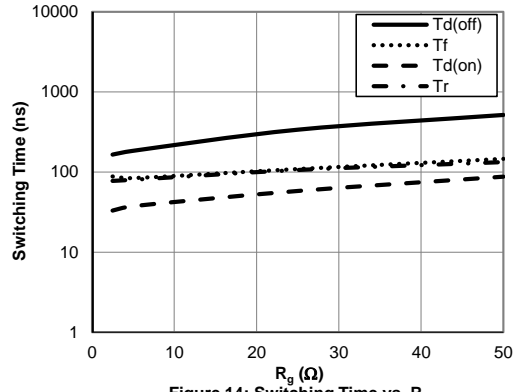


**Figure 12: Diode Reverse Leakage Current vs. Junction Temperature**

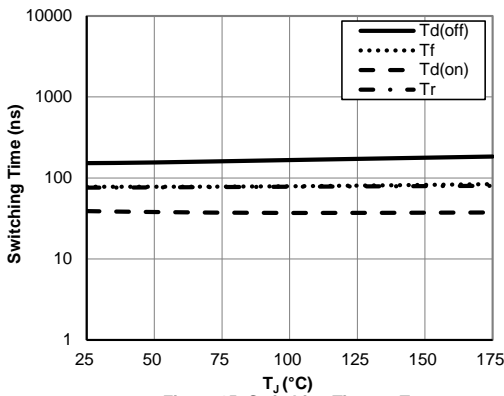
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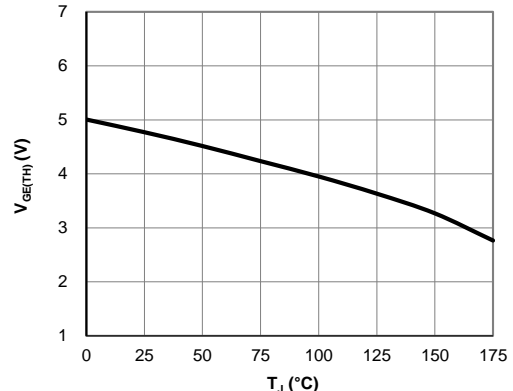
**Figure 13: Switching Time vs.  $I_C$**   
( $T_J=175^\circ\text{C}$ ,  $V_{GE}=15\text{V}$ ,  $V_{CE}=400\text{V}$ ,  $R_g=5\Omega$ )



**Figure 14: Switching Time vs.  $R_g$**   
( $T_J=175^\circ\text{C}$ ,  $V_{GE}=15\text{V}$ ,  $V_{CE}=400\text{V}$ ,  $I_C=60\text{A}$ )

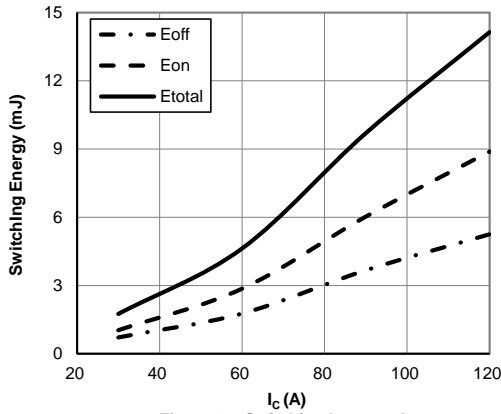


**Figure 15: Switching Time vs.  $T_J$**   
( $V_{GE}=15\text{V}$ ,  $V_{CE}=400\text{V}$ ,  $I_C=60\text{A}$ ,  $R_g=5\Omega$ )

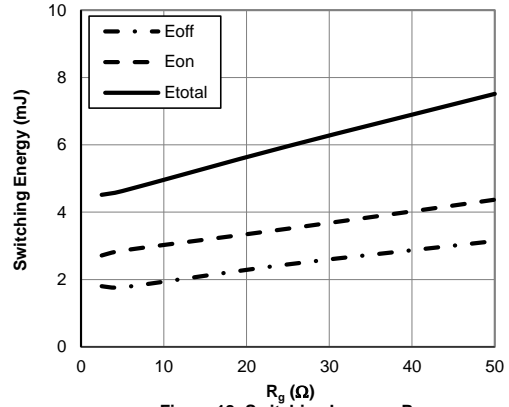


**Figure 16:  $V_{GE(TH)}$  vs.  $T_J$**

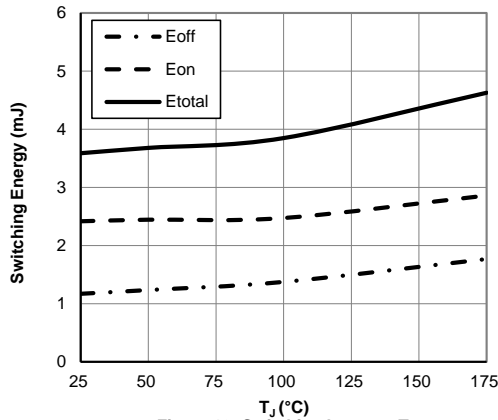
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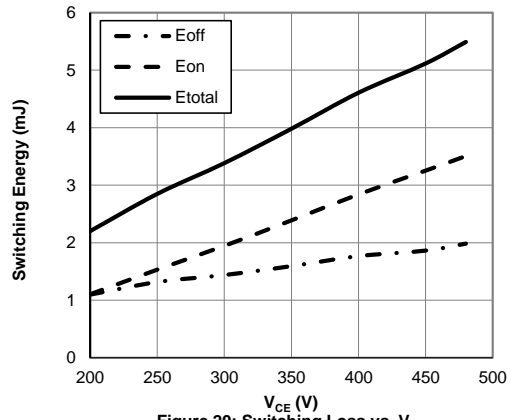
**Figure 17: Switching Loss vs.  $I_C$**   
( $T_J=175^\circ\text{C}$ ,  $V_{GE}=15\text{V}$ ,  $V_{CE}=400\text{V}$ ,  $R_g=5\Omega$ )



**Figure 18: Switching Loss vs.  $R_g$**   
( $T_J=175^\circ\text{C}$ ,  $V_{GE}=15\text{V}$ ,  $V_{CE}=400\text{V}$ ,  $I_C=60\text{A}$ )

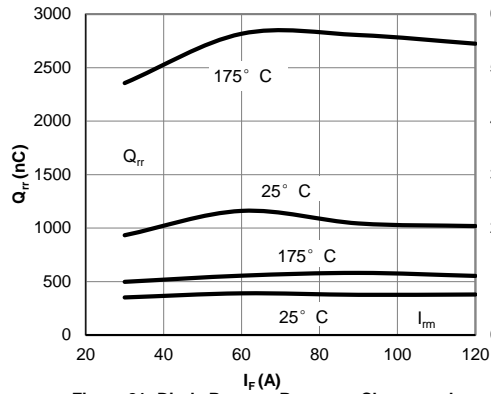


**Figure 19: Switching Loss vs.  $T_J$**   
( $V_{GE}=15\text{V}$ ,  $V_{CE}=400\text{V}$ ,  $I_C=60\text{A}$ ,  $R_g=5\Omega$ )

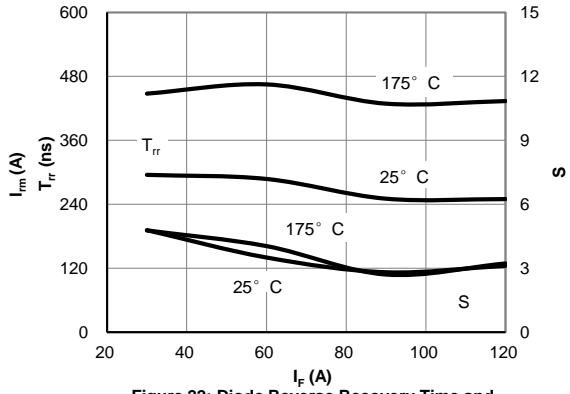


**Figure 20: Switching Loss vs.  $V_{CE}$**   
( $T_J=175^\circ\text{C}$ ,  $V_{GE}=15\text{V}$ ,  $I_C=60\text{A}$ ,  $R_g=5\Omega$ )

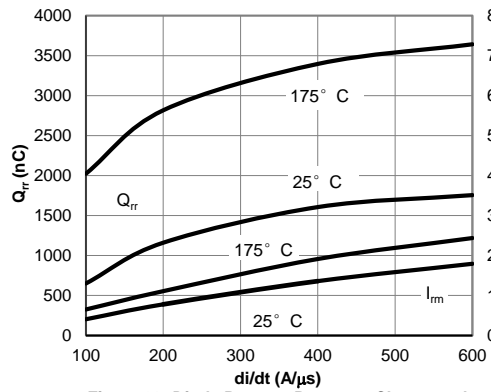
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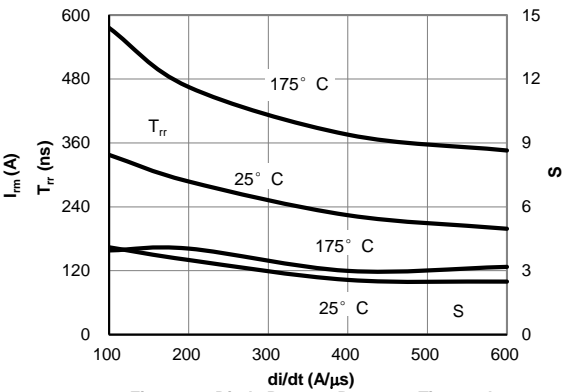
**Figure 21: Diode Reverse Recovery Charge and Peak Current vs. Conduction Current**  
( $V_{GE}=15V$ ,  $V_{CE}=400V$ ,  $di/dt=200A/\mu s$ )



**Figure 22: Diode Reverse Recovery Time and Softness Factor vs. Conduction Current**  
( $V_{GE}=15V$ ,  $V_{CE}=400V$ ,  $di/dt=200A/\mu s$ )

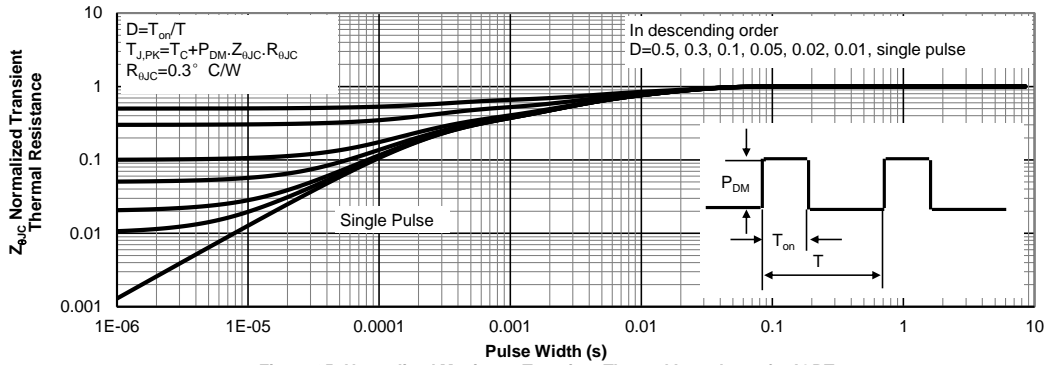


**Figure 23: Diode Reverse Recovery Charge and Peak Current vs. di/dt**  
( $V_{GE}=15V$ ,  $V_{CE}=400V$ ,  $I_F=60A$ )

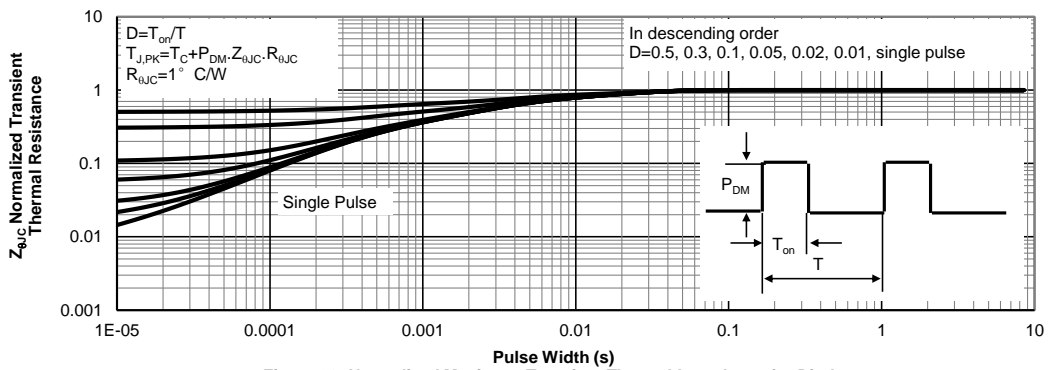


**Figure 24: Diode Reverse Recovery Time and Softness Factor vs. di/dt**  
( $V_{GE}=15V$ ,  $V_{CE}=400V$ ,  $I_F=60A$ )

**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**



**Figure 25: Normalized Maximum Transient Thermal Impedance for IGBT**



**Figure 26: Normalized Maximum Transient Thermal Impedance for Diode**



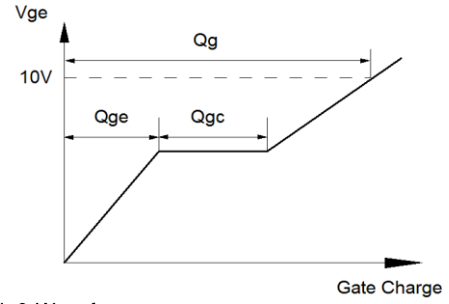
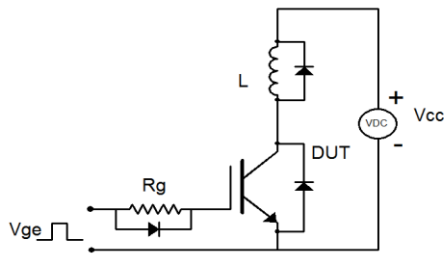


Figure A: Gate Charge Test Circuit & Waveforms

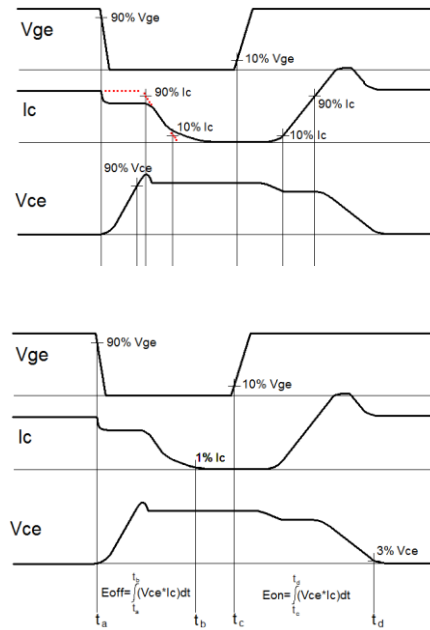
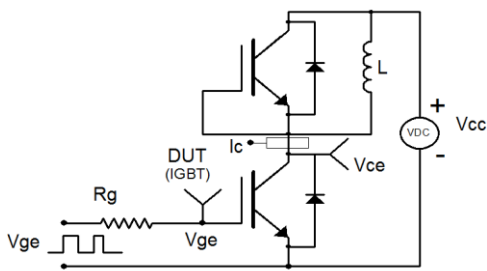


Figure B: Inductive Switching Test Circuit & Waveforms

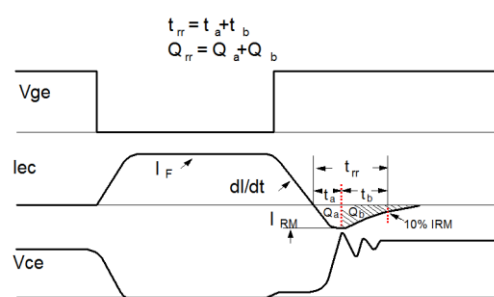
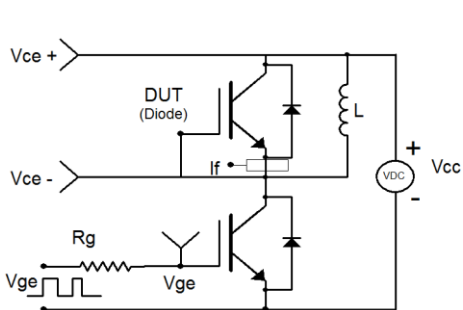


Figure C: Diode Recovery Test Circuit & Waveforms